

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Hej
10-19-00
Chaffin

In re Application of:

Kinsman et al.

Serial No.: 09/538,684

Filed: March 30, 2000

For: VARIED-THICKNESS HEAT SINK
FOR INTEGRATED CIRCUIT (IC)
PACKAGES AND METHOD OF
FABRICATING IC PACKAGES

Examiner: D. Graybill

Group Art Unit: 2814

Attorney Docket No.: 3056.1US (96-803.1)



CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

October 10, 2000
Date of Deposit

[Signature]
Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on date of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

Deidra Pfeil
Typed/printed name of person whose signature is contained above

RESPONSE TO RESTRICTION REQUIREMENT

Box Non-Fee Amendment
Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Applicants herein acknowledge the restriction requirement in the above-referenced application. Applicants hereby elect, without traverse of the Restriction Requirement, the claims of Group I., claims 1 through 20 and 22 through 45, drawn to a product, classified in Class 257, subclass 666.

RECEIVED
OCT 18 2000
TECHNOLOGY CENTER 2800

An early Office Action on the merits is respectfully solicited.

Respectfully submitted,

A handwritten signature in black ink, reading "James R. Duzan", followed by a long horizontal flourish.

James R. Duzan
Registration No. 28,393
Attorney for Applicants
TRASK BRITT
P. O. Box 2550
Salt Lake City, Utah 84110-2550
Telephone: (801) 532-1922

JRD/sls:djp

Date: October 10, 2000

N:\2269\3056.1\Response to Restriction Requirement.wpd